50V NPN LOW SATURATION TRANSISTOR IN SOT23

Features

- BV_{CEO} > 50V
- I_C = 4A Collector Current
- Low Saturation Voltage $V_{CE(sat)}$ < 60mV @ 1A
- Epitaxial Planar Die Construction
- High Peak Current and Gain
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/**

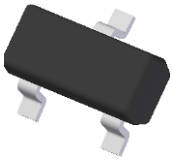
Mechanical Data

- Package: SOT23
- Package Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 e3
- Weight: 0.008 grams (Approximate)

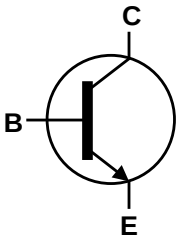
Applications

- DC-DC converters
- DC fans
- Power switches
- Motor controls
- MOSFET gate drivers

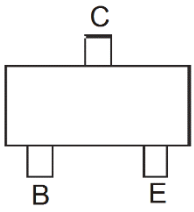
SOT23



Top View



Device Symbol



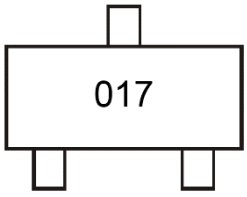
Top View
Pin-Out

Ordering Information (Note 4)

Part Number	Package	Marking	Reel Size (inches)	Tape Width (mm)	Packing	
					Qty.	Carrier
ZXTN25050DFHTA	SOT23	017	7	8	3,000	Reel

Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



017 = Product Type Marking Code

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

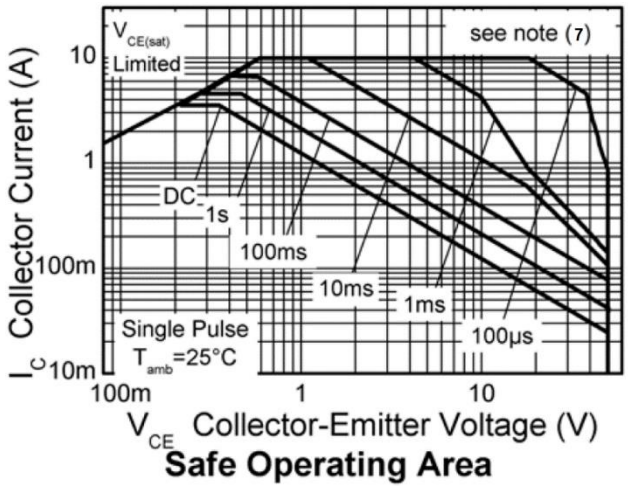
Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	150	V
Collector-Emitter Voltage	V_{CEO}	50	V
Emitter-Base Voltage	V_{EBO}	7	V
Collector-Emitter Voltage (Forward Blocking)	V_{CEX}	150	V
Emitter-Collector Voltage (Reverse Blocking)	V_{ECO}	5	V
Base Current	I_B	1	A
Continuous Collector Current	I_C	4	A
Peak Collector Current	I_{CM}	10	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

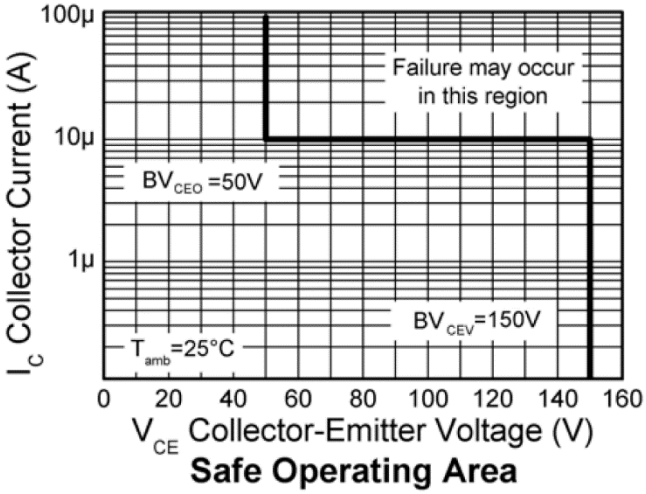
Characteristic		Symbol	Value	Unit
Power Dissipation Linear Derating Factor	(Note 5)	P_D	0.73 5.84	W mW/°C
	(Note 6)		1.05 8.4	
	(Note 7)		1.25 9.6	
	(Note 8)		1.81 14.5	
Thermal Resistance, Junction to Ambient	(Note 5)	$R_{\theta JA}$	171	°C/W
	(Note 6)		119	
	(Note 7)		100	
	(Note 8)		69	
Thermal Resistance, Junction to Case	(Note 9)	$R_{\theta JC}$	13	°C/W
Operating and Storage Temperature Range		T_J, T_{STG}	-55 to +150	°C

Notes:
5. For the device mounted on 15mm x 15mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.
6. For the device mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions.
7. For the device mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions.
8. Same as Note 7, except measured at t < 5 seconds.
9. For the device mounted on minimum recommended pad layout FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

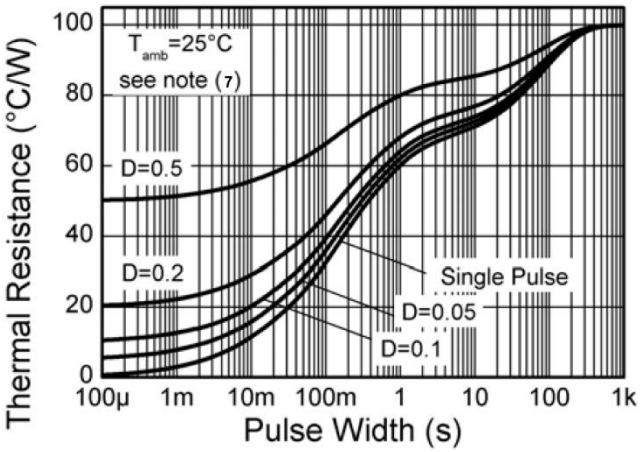
Thermal Characteristics



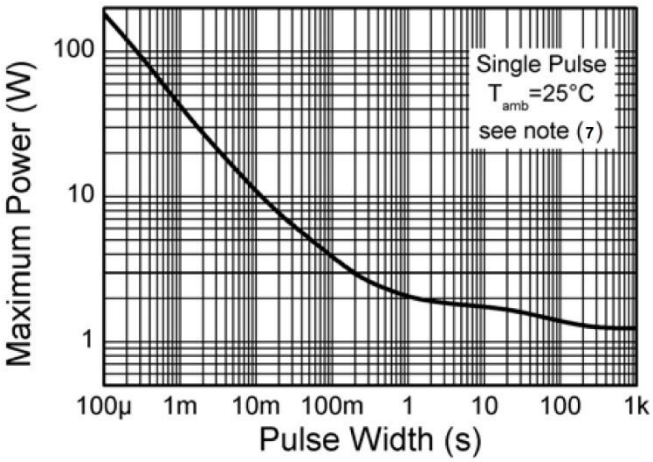
Safe Operating Area



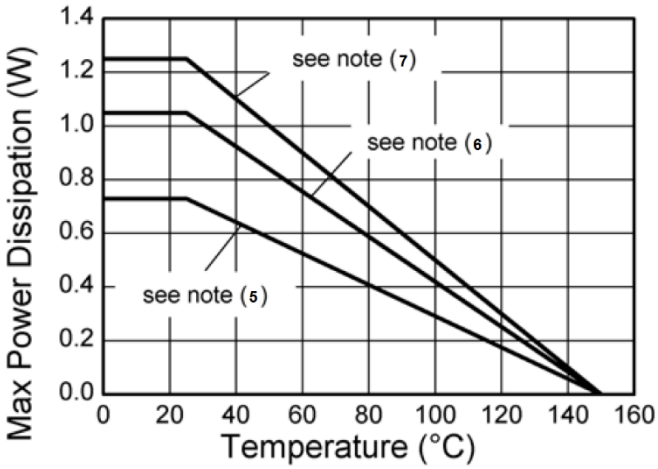
Safe Operating Area



Transient Thermal Impedance



Pulse Power Dissipation



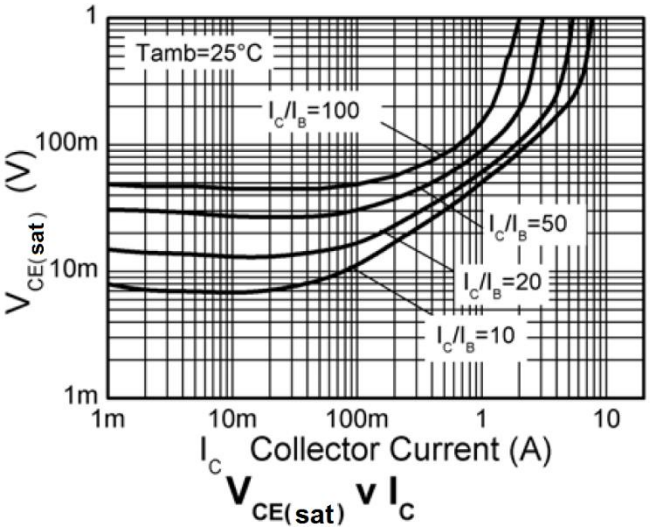
Derating Curve

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

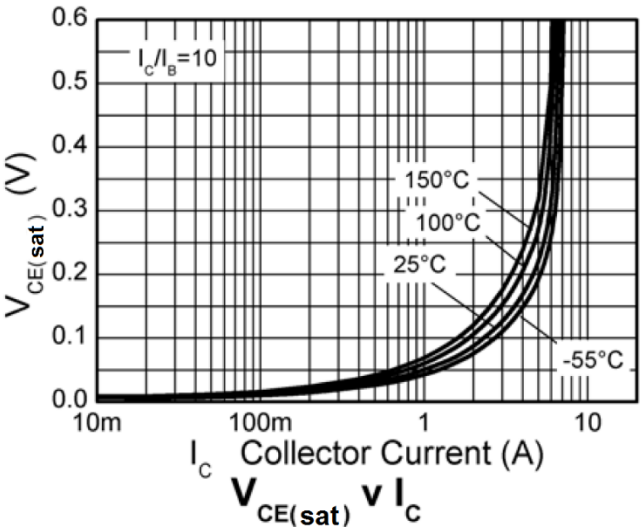
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV_{CBO}	150	180	—	V	I_C = 100µA
Collector-Emitter Breakdown Voltage (Note 10)	BV_{CEO}	50	67	—	V	I_C = 10mA
Emitter-Base Breakdown Voltage	BV_{EBO}	7.0	8.3	—	V	I_E = 100µA
Emitter-Collector Breakdown Voltage	BV_{ECO}	5.0	7.4	—	V	I_E = 100µA
Emitter-Collector Breakdown Voltage	BV_{ECX}	5.0	8.0	—	V	I_E = 100µA, R_{BC} ≤ 1kΩ or -0.25V < V_{BC} < 0.25V
Collector-Emitter Breakdown Voltage	BV_{CEX}	150	180	—	V	I_C = 100µA, R_{BE} ≤ 1kΩ or -1V < V_{BE} < 0.25V
Collector Cutoff Current	I_{CBO}	—	1	50	nA	V_{CB} = 150V
		—	—	20	µA	V_{CB} = 150V, T_{amb} = +100°C
Emitter Cutoff Current	I_{EBO}	—	1	50	nA	V_{EB} = 5.6V
Collector-Emitter Cutoff Current	I_{CEX}	—	—	100	nA	V_{CE} = 150V, R_{BE} ≤ 1kΩ or -1V < V_{BE} < 0.25V
ON CHARACTERISTICS (Note 10)						
DC Current Gain	h_{FE}	300	450	900	—	I_C = 10mA, V_{CE} = 2V
		240	410	—		I_C = 1A, V_{CE} = 2V
		20	40	—		I_C = 4A, V_{CE} = 2V
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	—	50	60	mV	I_C = 1A, I_B = 100mA
		—	160	260		I_C = 1A, I_B = 10mA
		—	180	250		I_C = 2A, I_B = 40mA
		—	190	235		I_C = 3.5A, I_B = 175mA
		—	160	210		I_C = 4A, I_B = 400mA
Base-Emitter Saturation Voltage	$V_{BE(sat)}$	—	970	1070	mV	I_C = 4A, I_B = 400mA
Base-Emitter Turn-On Voltage	$V_{BE(on)}$	—	870	970	mV	I_C = 4A, V_{CE} = 2V
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance (Note 10)	C_{obo}	—	12	20	pF	V_{CB} = 10V, f = 1MHz
Transition Frequency	f_T	—	200	—	MHz	V_{CE} = 10V, I_C = 50mA f = 100MHz
SWITCHING CHARACTERISTICS						
Delay Time	t_d	—	65	—	ns	V_{CC} = 10V, I_C = 1A I_{B1} = -I_{B2} = 10mA
Rise Time	t_r	—	111	—	ns	
Storage Time	t_s	—	429	—	ns	
Fall Time	t_f	—	140	—	ns	

Note: 10. Measured under pulsed conditions. Pulse width ≤ 300µs. Duty cycle ≤ 2%.

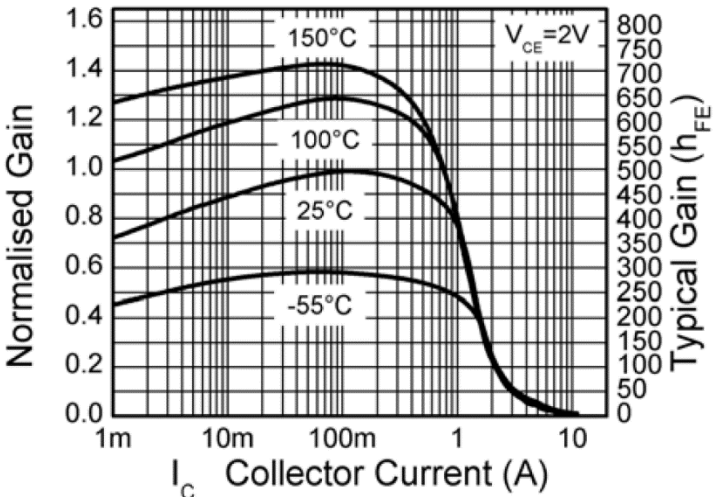
Typical Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)



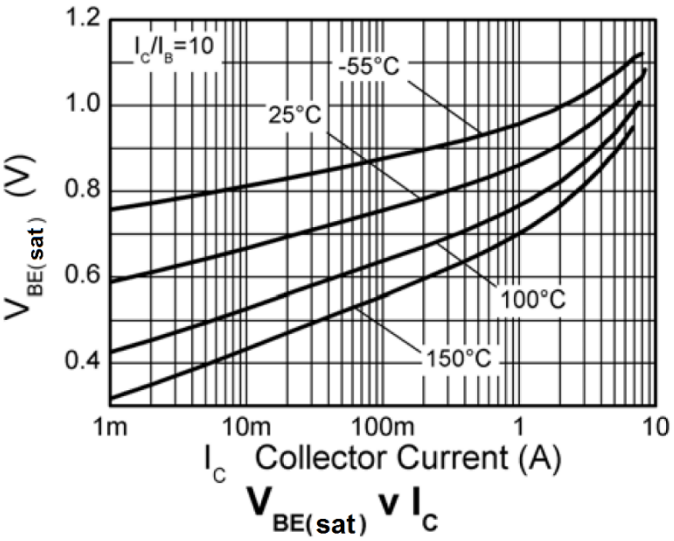
$V_{CE(sat)}$ v I_C



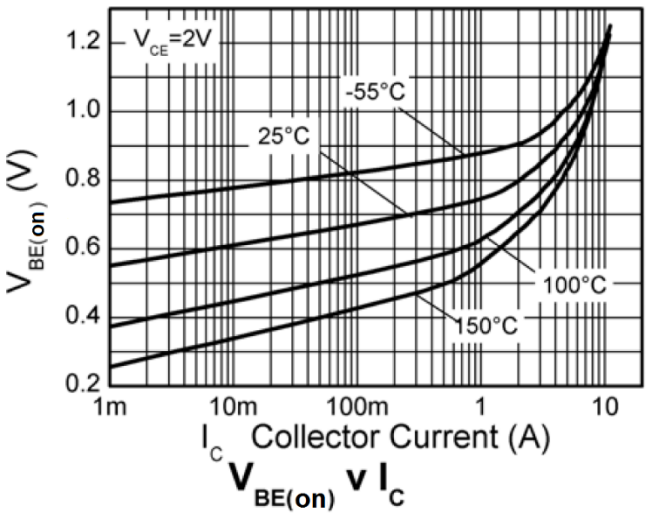
$V_{CE(sat)}$ v I_C



h_{FE} v I_C



$V_{BE(sat)}$ v I_C

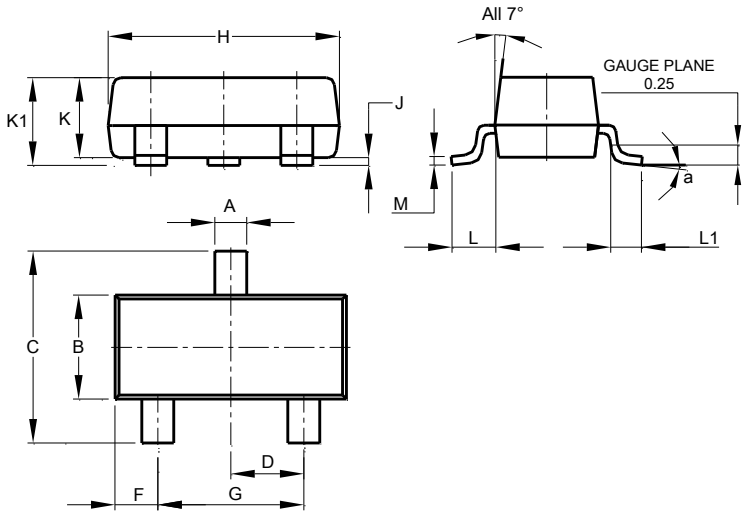


$V_{BE(on)}$ v I_C

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

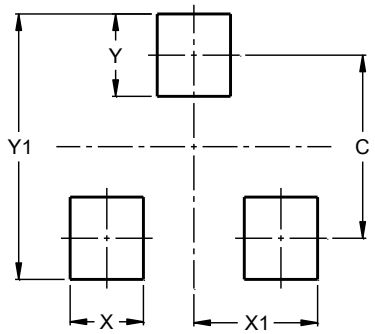


SOT23			
Dim	**Min**	**Max**	**Typ**
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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